

Surface Mount Schottky Barrier Rectifier

Reverse Voltage - 20 to 200 V

Forward Current - 5.0A

Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: SMA
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 60mg / 0.0021oz

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode

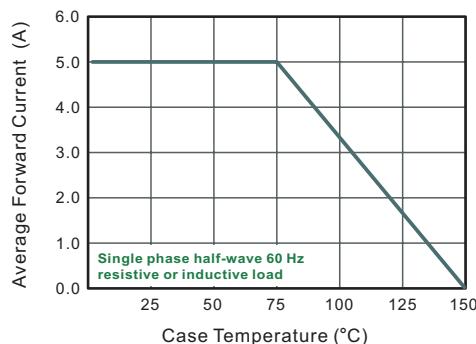
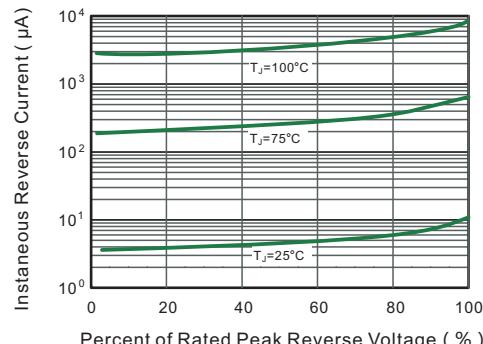
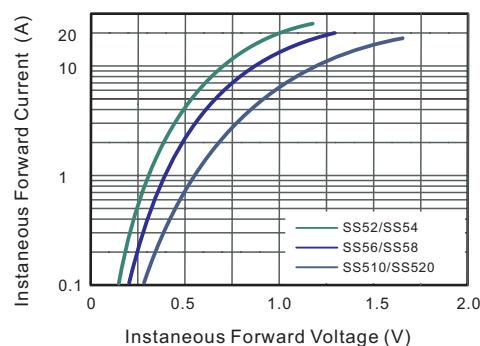
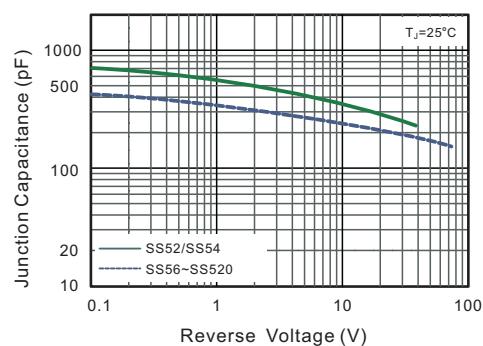
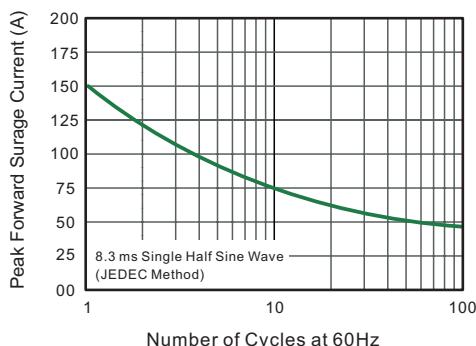
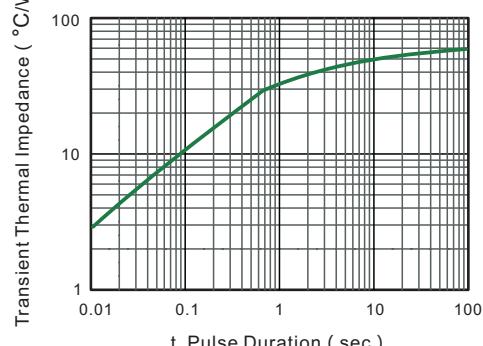


Top View
 Marking Code: SS52~SS520
 Simplified outline SMA and symbol

Parameter	Symbols	SS52	SS54	SS56	SS58	SS510	SS512	SS515	SS520	Units			
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	20	40	60	80	100	120	150	200	V			
Maximum RMS voltage	V _{RMS}	14	28	42	56	70	84	105	140	V			
Maximum DC Blocking Voltage	V _{DC}	20	40	60	80	100	120	150	200	V			
Maximum Average Forward Rectified Current	I _{F(AV)}	5.0							A				
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	150							A				
Max Instantaneous Forward Voltage at 5 A	V _F	0.55		0.70		0.85			V				
Maximum DC Reverse Current T _a = 25°C at Rated DC Reverse Voltage T _a = 100°C	I _R	1.0 50							mA				
Typical Junction Capacitance ⁽¹⁾	C _j	500		300			pF						
Typical Thermal Resistance ⁽²⁾	R _{θJA}	60							°C/W				
Operating Junction Temperature Range	T _j	-55 ~ +150							°C				
Storage Temperature Range	T _{stg}	-55 ~ +150							°C				

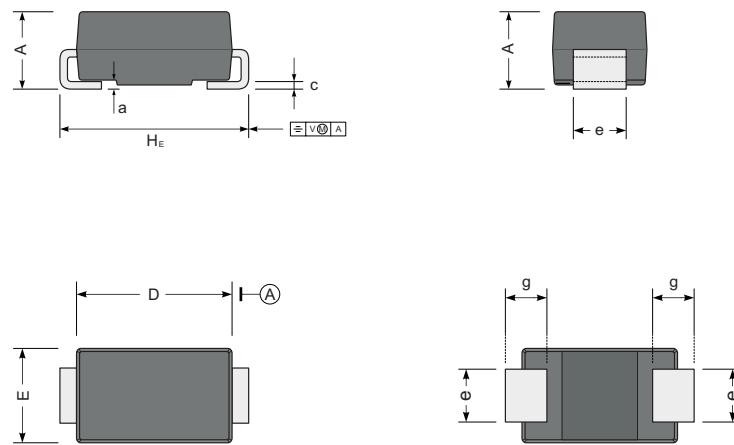
(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C.

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

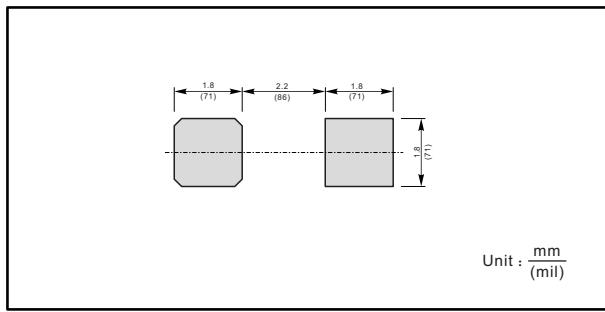
Fig.1 Forward Current Derating Curve

Fig.2 Typical Reverse Characteristics

Fig.3 Typical Forward Characteristic

Fig.4 Typical Junction Capacitance

Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

Fig.6- Typical Transient Thermal Impedance


PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMA


UNIT		A	D	E	H _E	c	e	g	a
mm	max	2.2	4.5	2.7	5.2	0.31	1.6	1.5	0.3
	min	1.9	4.0	2.3	4.7	0.15	1.3	0.9	
mil	max	87	181	106	205	12	63	59	12
	min	75	157	91	185	6	51	35	

The recommended mounting pad size

Marking

Type number	Marking code
SS52	SS52
SS54	SS54
SS56	SS56
SS58	SS58
SS510	SS510
SS512	SS512
SS515	SS515
SS520	SS520